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To the Director of the United States Pa

a attached original documents or copy thereof.

1. Name of conveying party(ies):

Seong Ho YOON

2. Name and address of receiving party(ies):

Name: NEXEN NANO TECH. CO., LTD.

Address: 373-1 Guseong-dong, Yaiseong-gu

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Daejeon State/Prov.:

Country: Republic of Korea ZIP: 305-701

Execution Date: April 6, 2005

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: April 6, 2005

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jae Y. Park

Registration No. PLEASE SEE ATTACHED

Address: Cantor Colburn LLP

55 Griffin Road South

City: Bloomfield

State/Prov.: CT

Country: USA

ZIP: 06002

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

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8. Deposit account number:

06-1130

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jae Y. Park

Name of Person Signing

Signature

April 18, 2005

Date

3

Total number of pages including cover sheet, attachments, and

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PATENT
REEL: 017117 FRAME: 0575

ASSIGNMENT

WHEREAS I, YOON, Seong Ho, (hereinafter referred to as "ASSIGNOR"), of 152-1 Shinsong-dong, Yuseong-gu, 305-805 Daejeon, Republic of Korea have invented certain new and useful improvements in:

ULTRA-FINE FIBROUS CARBON AND PREPARATION METHOD THEREOF

for which I am about to file an application for Letters Patent of the United States;

AND WHEREAS, NEXEN NANO TECH CO., LTD., (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea, having a place of business at 373-1 Guseong-dong, Yaisong-gu, 305-701 Daejeon, Republic of Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so

made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: APR 6, 2005



YOON, Seong Ho

L.S.